

US00D904640S

(12) **United States Design Patent** (10) **Patent No.:** **US D904,640 S**
Ruhland et al. (45) **Date of Patent:** **** Dec. 8, 2020**

(54) **SUBSTRATE CARRIER**

(71) Applicant: **APPLIED MATERIALS, INC.**, Santa Clara, CA (US)
(72) Inventors: **Fred Eric Ruhland**, Santa Clara, CA (US); **Sumit S. Patankar**, Fremont, CA (US); **Vijay D. Parkhe**, San Jose, CA (US); **Daniel Lee Diehl**, Chiba (JP); **Mingwei Zhu**, Sunnyvale, CA (US); **Hiroyuki Takahama**, Chiba-Ken (JP); **Randy D. Schmieding**, Saratoga, CA (US)
(73) Assignee: **APPLIED MATERIALS, INC.**, Santa Clara, CA (US)

(**) Term: **15 Years**

(21) Appl. No.: **29/677,482**

(22) Filed: **Jan. 21, 2019**

(51) **LOC (12) Cl.** **24-02**

(52) **U.S. Cl.**
USPC **D24/225**

(58) **Field of Classification Search**
USPC D24/223–227; D7/323, 332, 335–337, D7/359–364, 387–388, 402, 407, 667; D8/70; D15/133
CPC G01N 1/30; G01N 1/2806; G01N 1/312; B01L 3/502723; B01L 3/502738; H01L 21/68728
See application file for complete search history.

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Primary Examiner — Susan Bennett Hattan

Assistant Examiner — Omeed Agilee

(74) *Attorney, Agent, or Firm* — Moser Taboada

(57) **CLAIM**

The ornamental design for a substrate carrier, as shown and described.

DESCRIPTION

FIG. 1 is a perspective view of a substrate carrier, according to one embodiment of the novel design.

FIG. 2 is a top plan view thereof.

FIG. 3 is a bottom plan view thereof.

FIG. 4 is a front elevation view thereof.

FIG. 5 is a back elevation view thereof.

FIG. 6 is a left side elevation view thereof.

FIG. 7 is a right side elevation view thereof.

FIG. 8 is a perspective view of a substrate carrier, according to another embodiment of the novel design.

FIG. 9 is a top plan view thereof. The broken lines, the areas within them, and the areas surrounded by both broken lines and solid lines depict portions of the substrate carrier that form no part of the claimed design.

FIG. 10 is a bottom plan view thereof. The bottom surface and outer boundaries of the substrate carrier form no part of the claim.

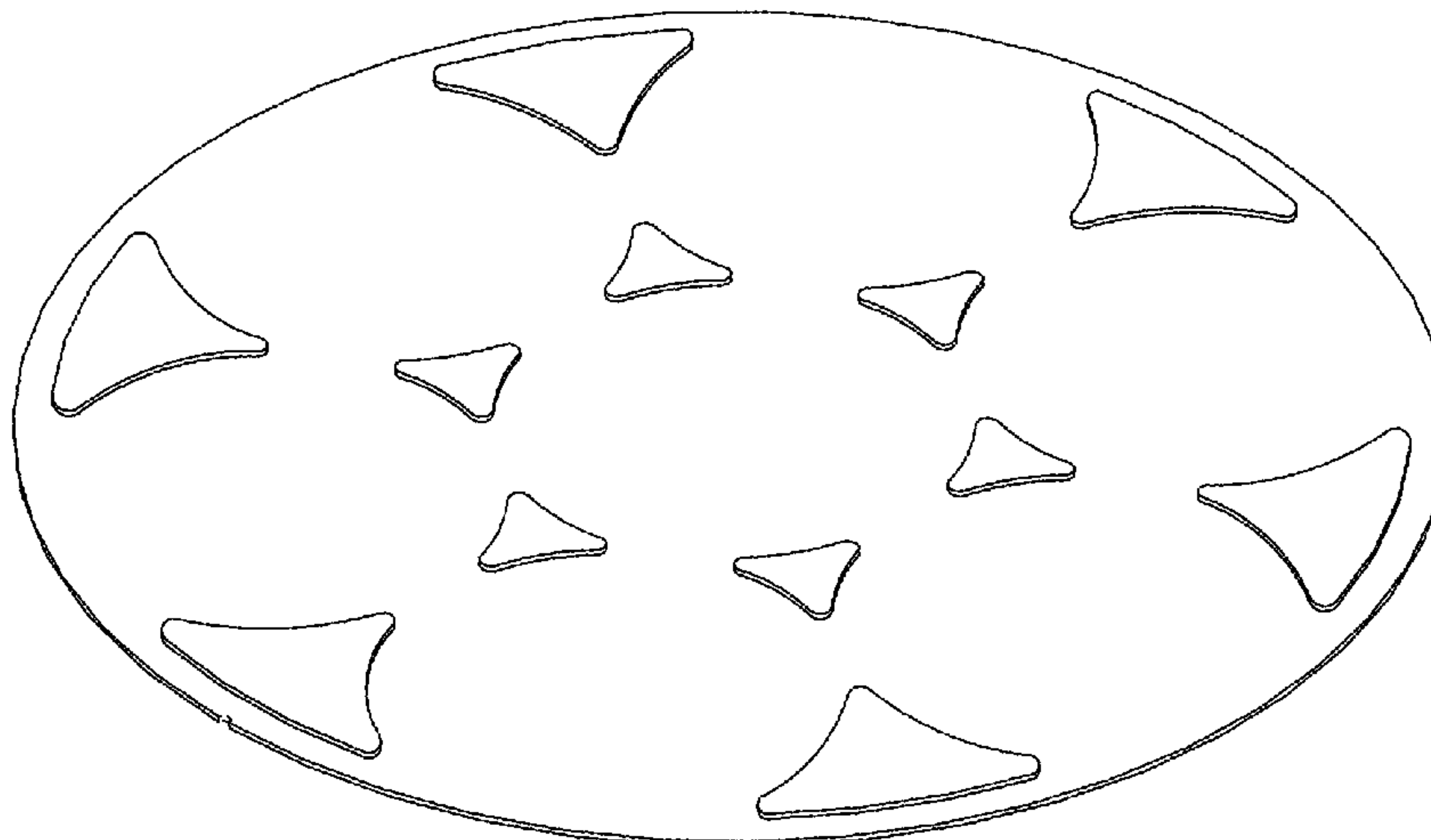
FIG. 11 is a front elevation view thereof.

FIG. 12 is a back elevation view thereof.

FIG. 13 is a left side elevation view thereof; and,

FIG. 14 is a right side elevation view thereof.

1 Claim, 10 Drawing Sheets



(56) **References Cited**

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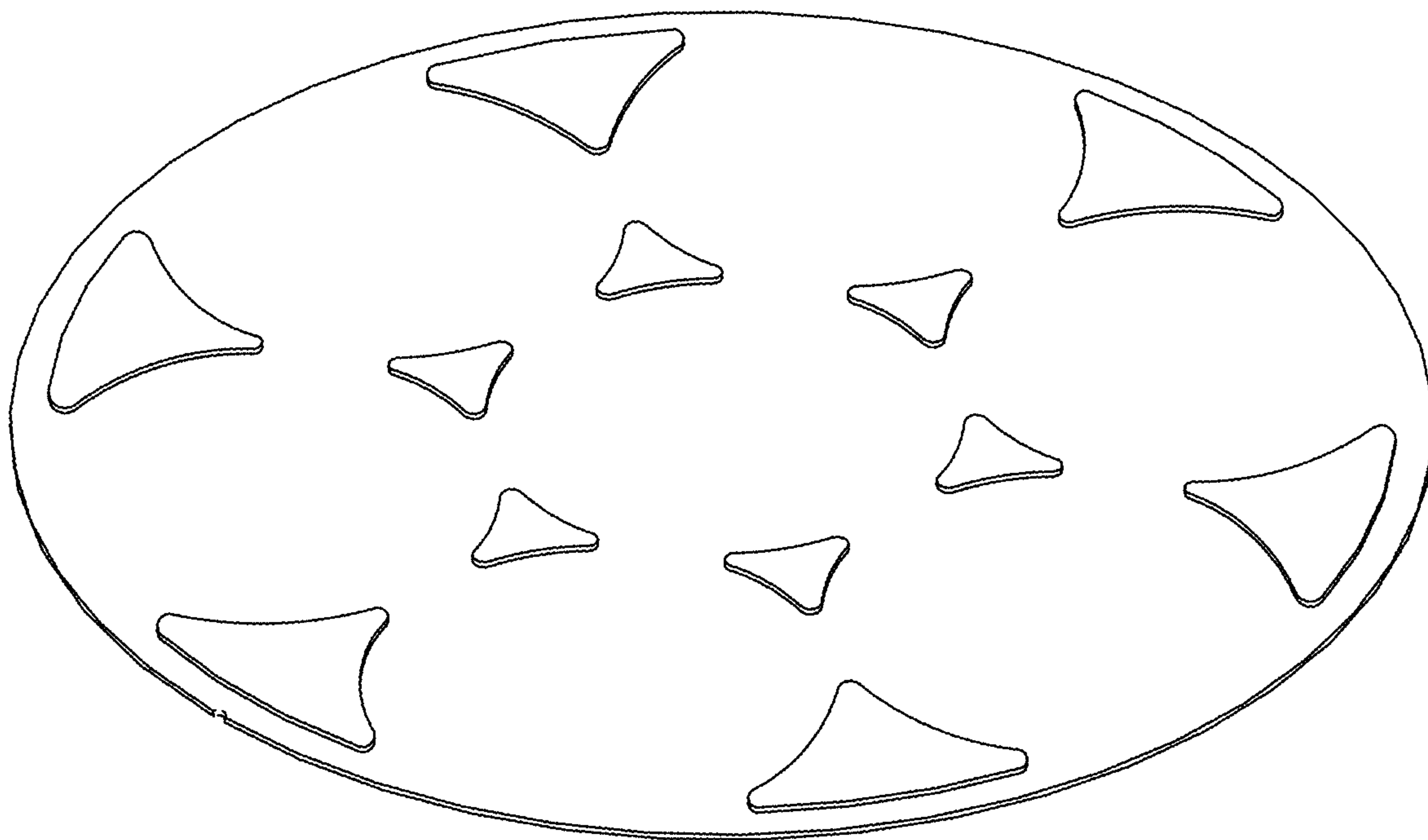


FIG. 1

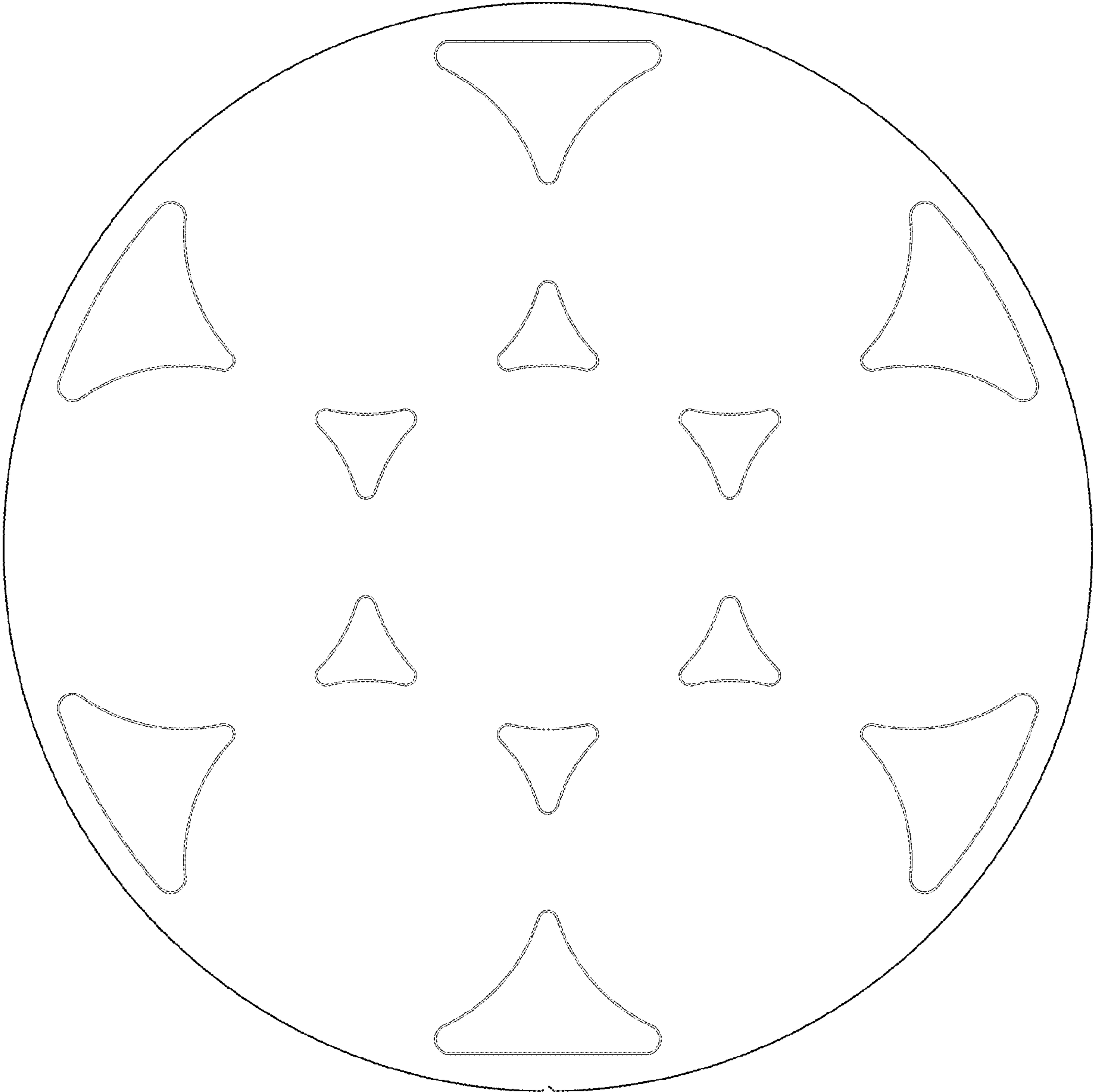


FIG. 2

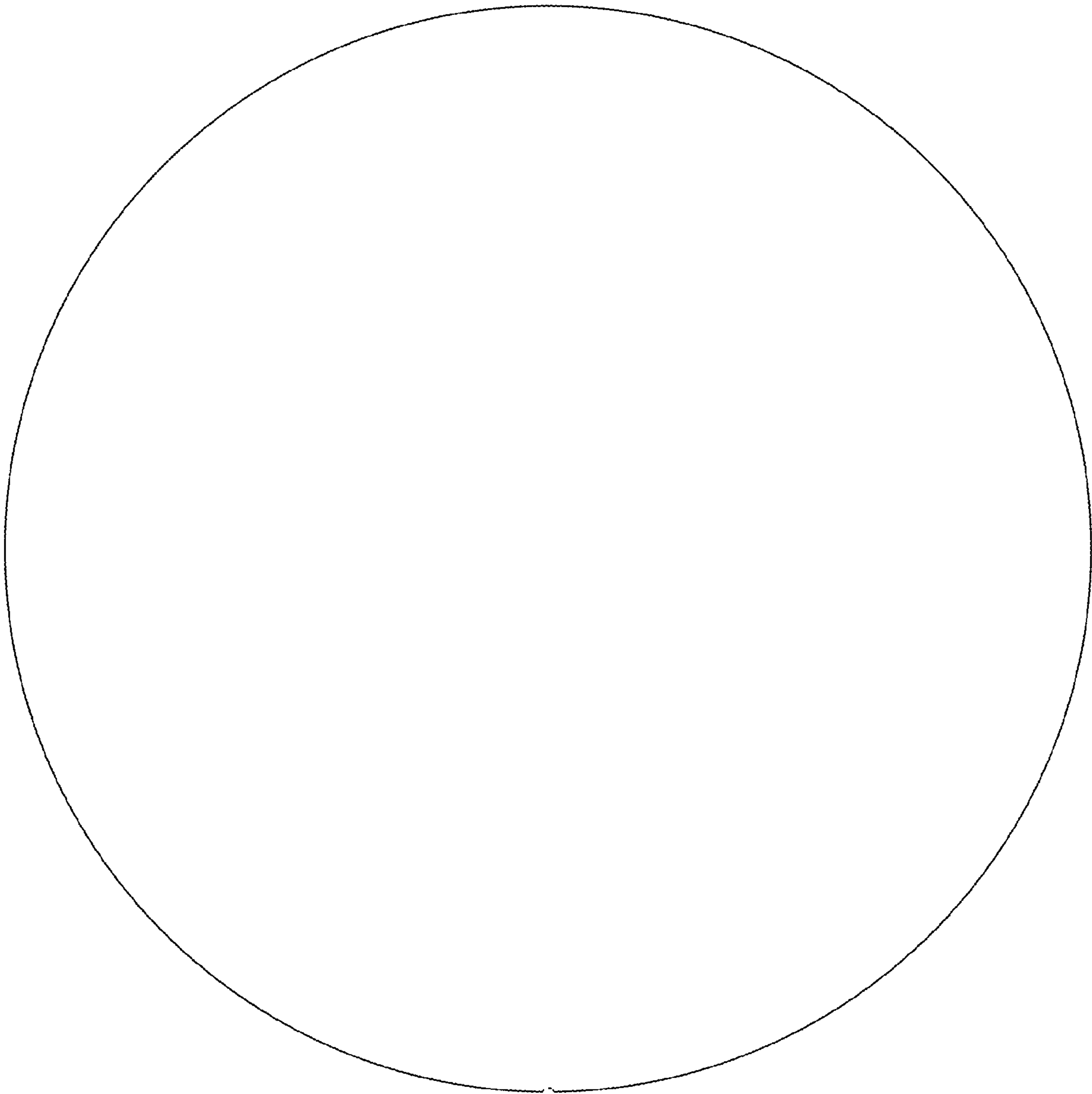


FIG. 3

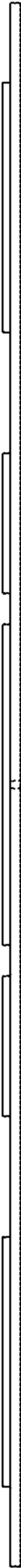


FIG. 4



FIG. 5



FIG. 6

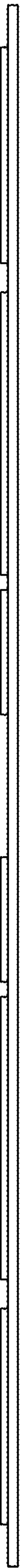


FIG. 7

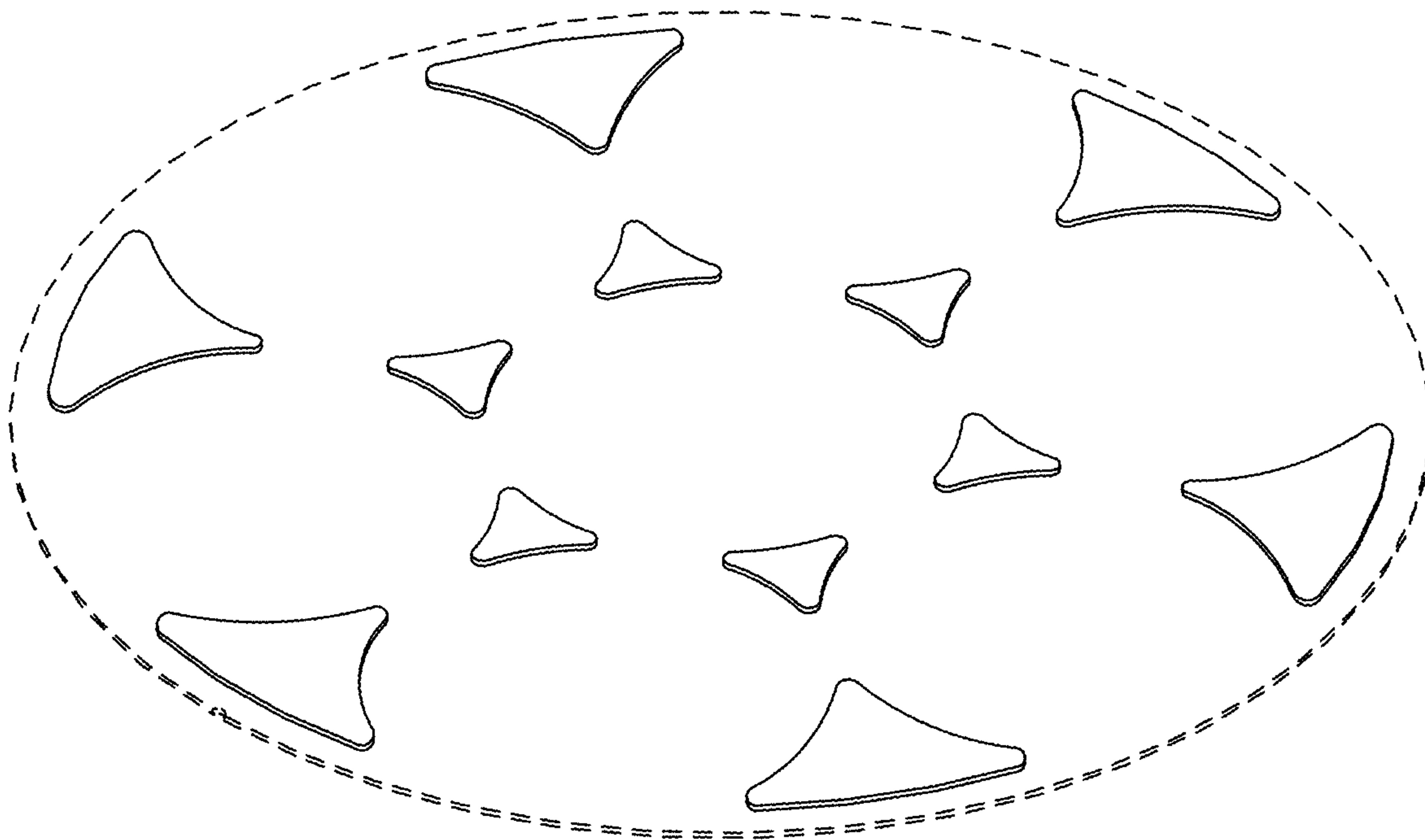


FIG. 8

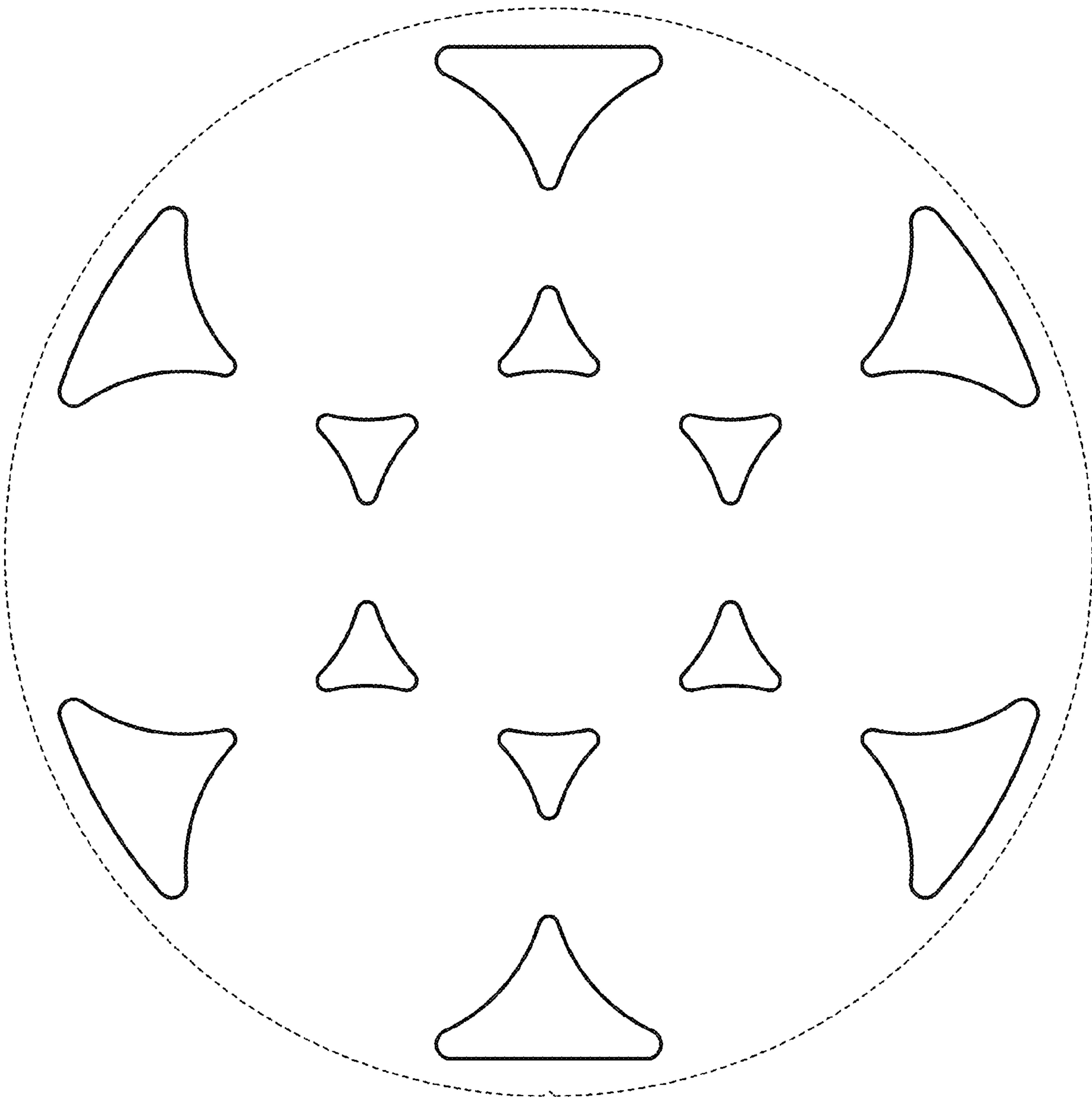


FIG. 9

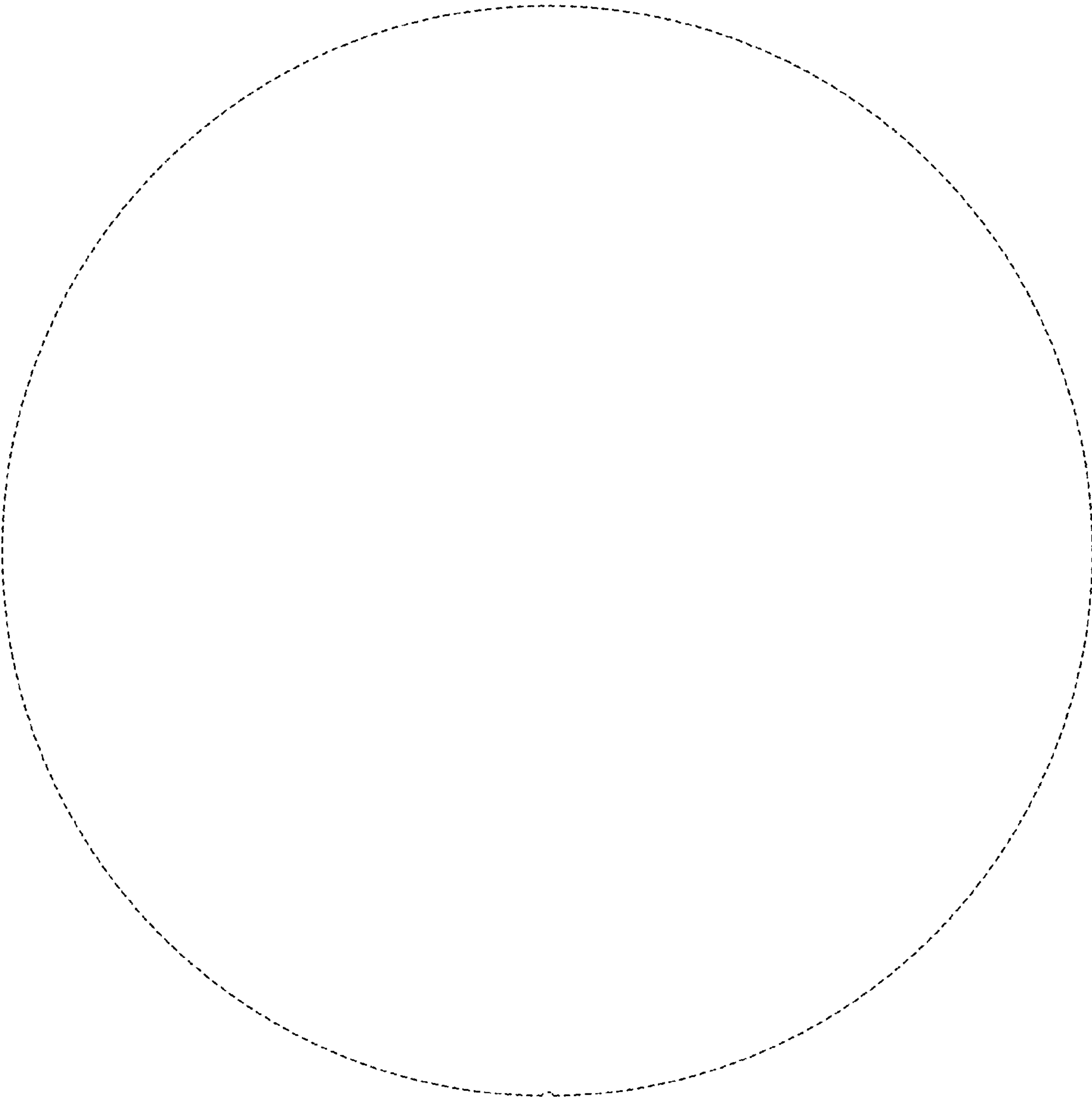


FIG. 10

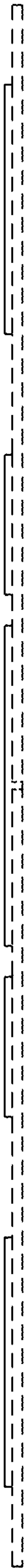


FIG. 11

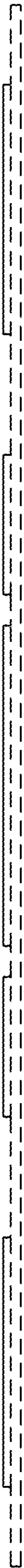


FIG. 12

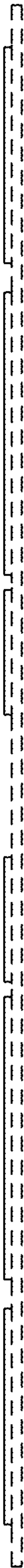


FIG. 13

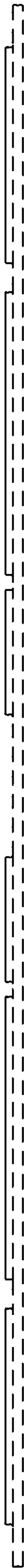


FIG. 14

UNITED STATES PATENT AND TRADEMARK OFFICE
CERTIFICATE OF CORRECTION

PATENT NO. : D904,640 S
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INVENTOR(S) : Ruhland et al.

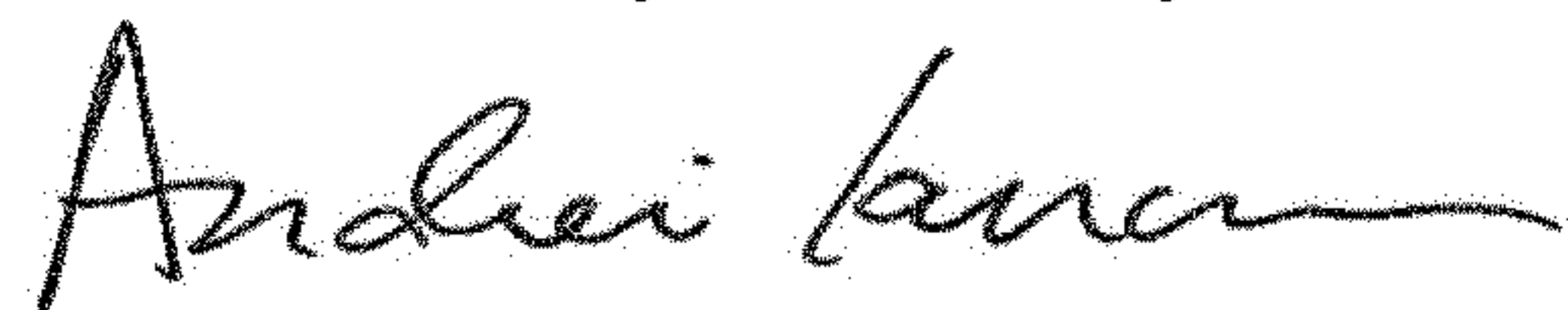
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It is certified that error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

On the Title Page

On page 2, Column 1, item (56) in Other Publications, delete “Taiwan Design Application number 106304361” and replace with “Taiwan Design Application number 108304381”

Signed and Sealed this
Twelfth Day of January, 2021



Andrei Iancu
Director of the United States Patent and Trademark Office